

AMP DISPLAY INC.

SPECIFICATIONS

5.7-in COLOR TFT MODULE

CUSTOMER:	
CUSTOMER PART NO.	
AMP DISPLAY PART NO.	AM-320240NSTNQW-00H (500 nits)
APPROVED BY:	
DATE:	

APPROVED FOR SPECIFICATIONS

APPROVED FOR SPECIFICATION AND PROTOTYPES

AMP DISPLAY INC

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RECORD	OF	REVISION
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Revision Date	Page	Contents	Editor
2007/7/13	-	New Release	Sunglin
2007/7/18	9	Modify LCD Viewing Angle	Edward

1 Features

5.7 inch Amorphous-TFT-LCD (Thin Film Transistor Liquid Crystal Display) module. This module is composed of a 5.7" TFT-LCD panel, a driver circuit and backlight unit.

(1) Construction: 5.7" a-Si color TFT-LCD, White LED Backlight and PCB.

- (2) Resolution (pixel): 320(R.G.B) X240
- (3) Number of the Colors : 262K colors (R , G , B 6 bit digital each)
- (4) LCD type : Transmissive Color TFT LCD (normally White)
- (5) Interface: 33 pin
- (6) Power Supply Voltage: 3.3V single power input. Built-in power supply circuit.
- (7) Viewing Direction: 12 O'clock (The direction it's hard to be discolored)

2 Physical specifications

Item	Specifications	Unit
Display resolution(dot)	960 (W) x 240(H)	mm
Active area	115.2 (W) x 86.4 (H)	mm
Screen size	5.7(Diagonal)	mm
Pixel size	120 (W) x 360 (H)	um
Color configuration	R.G.B stripe	
Overall dimension	144.0(W)x104.6(H)x13.0(D)	mm
Weight	T.B.D	mg
Backlight unit	LED	

3 Electrical specification

3.1 Absolute max. ratings

3.1.1 Electrical Absolute max. ratings

ltem	Symbol	Condition	Min.	Max.	Unit	Remark
Power voltage	VCC	VSS=0	-0.3	6.0	V	
Input voltege	V _{in}		-0.3	VCC+0.3	V	Note 1

Note1:Hsync, Vsync, ENAB, CK, R0~R5, G0~G5, B0~B5

3.1.2 Environmental Absolute max. ratings

_	OPERATING		STOF	RAGE	
Item	MIN	MAX	MIN	MAX	Remark
Temperature	-20	70	-30	80	Note2,3,4,5,7
Humidity	No	te1	No	te1	
Corrosive Gas	Not Acceptable		Not Acceptable		

Note1 : Ta <= 40°C : 85% RH max

Ta > 40°C : Absolute humidity must be lower than the humidity of 85%RH at 40°C

- Note2 : For storage condition Ta at -30°C < 48h , at 80°C < 100h For operating condition Ta at -20°C < 100h
- Note3 : Background color changes slightly depending on ambient temperature. This phenomenon is reversible.
- Note4 : The response time will be slower at low temperature.
- Note5 : Only operation is guarantied at operating temperature. Contrast , response time, another display quality are evaluated at +25°C
- Note6 : When LCM is operated over 60°C ambient temperature, the I_L of the CCFL back-light should be adjusted to 3mA max
- Note7 : This is panel surface temperature, not ambient temperature.
- Note8 : When LCM be operated less than 0°C , the life time of the CCFL back-light will be reduced. The rise time of the CCFL ON will be longer when the ambient temperature below 0°C and confirm the characteristics of inverter is nessary.

3.2 Electrical characteristics

3.2.1 DC Electrical characteristic of the LCD

Typical operting conditions (\	VS	S=0V))	

Item	,	Symbol	Min.	Тур.	Max.	Unit	Remark
Power supply		VCC	3.0	3.3	3.6	V	
Input Voltage	H Level	V _{IH}	0.7 VCC	-	VCC	V	Note 1
for logic	L Level	VIL	0	-	0.3 VCC	V	NOLE I
Power Supply c	urrent	ICC		45	55	mA	Note 2

Note1: Hsync, Vsync, DEN, DCLK, R0~R5, G0~G5, B0~B5

Note2: fv =60Hz , Ta=25°C , Display pattern : All Black

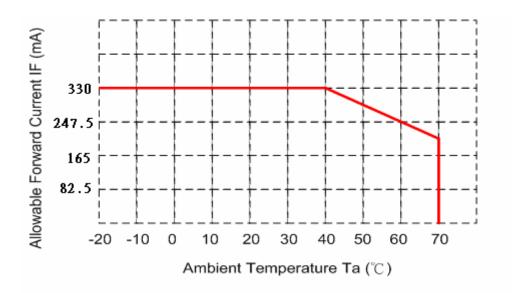
J.Z.Z LIECU	5.2.2 Liectrical characteristic of LED Dack-light										
Paramenter	Symbol	Min.	Тур.	Max.	Unit	Condiction					
LED voltage	V _{ak}		10.5	12	V	I _{LED} =330mA,Ta=25°С					
LED forward current	I _{LED}		330	360	mA	Ta=25°C					
	I _{LED}		210	240	mA	Ta=60°C					
Lamp life time		10,000	-	-	Hr	I _{LED} =330mA,Ta=25℃					

3.2.2 Electrical characteristic of LED Back-light

■ The constant current source is needed for white LED back-light driving.

When LCM is operated over 60°C ambient temperature, the ILED of the LED

back-light should be adjusted to 105mA max

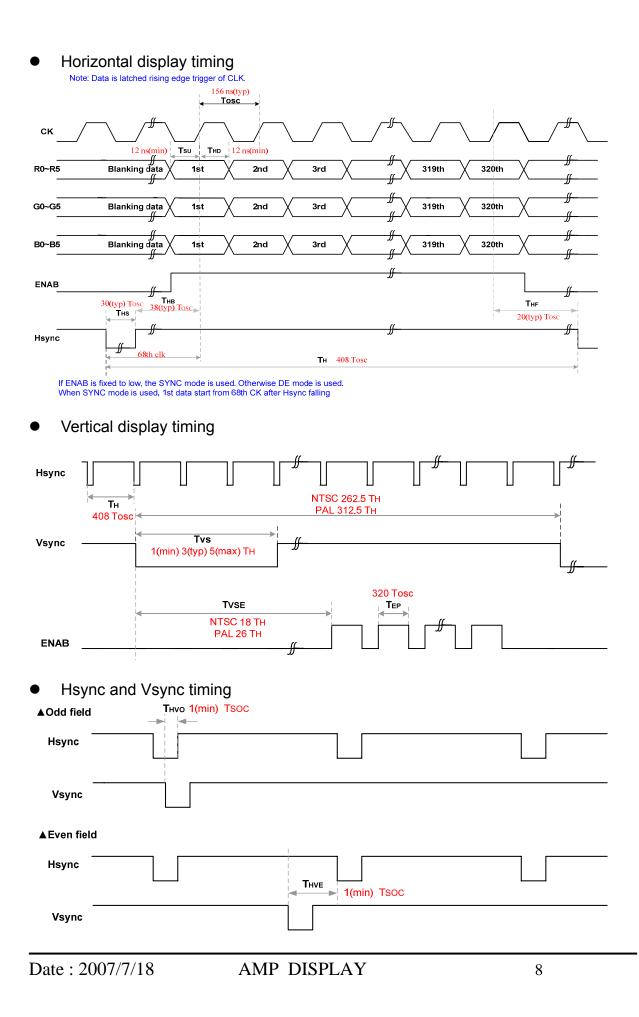


3.3 AC Timing characteristic of the LCD

Signal	Parameter		Symbol	Min.	Тур.	Max	Unit.	Remark
DCLK	DCLK period		Tosc	-	156	-	ns	
	Frequency		Fosc	_	6.4	-	MHz	
	DCLK High plus wid	th	Тсн	-	78	-	ns	
	DCLK Low plus wid	th	TCL	-	78	-	ns	
RGB	Data setup time		TSU	12	-	-	ns	
DATA	Data hold time		THD	12	-	-	ns	
Hsync	Hsync period		Тн	-	408	-	Tosc	
	Hsync pulse width		THS	5	30	-	Tosc	
	Back-Parch		Тнв		38		Tosc	
	Front-Parch		THF		20		Tosc	
	Hsync rising time		TCr	-	_	700	ns	
	Hsync falling time		TCf	-	-	300	ns	
Vsync	Vsync period	NTSC		-	262.5	-	Тн	
	v sync period	PAL		-	312.5	-	Тн	
	Vsync pulse width	_	Tvs	1	3	5	Тн	
	Back-Porch	NTSC	Тив		15		Тн	
		PAL			23		Тн	
	Display Period		TVD		240		Тн	
	Front Porch	NTSC	TVF		4.5		Тн	
		PAL			46.5		Тн	
	Vsync rising time		TVr	-	-	700	ns	
	Vsync falling time		TVf	-	-	1.5	μ S	
	Vsync falling to Hsync rising time for odd field Vsync falling to Hsync falling time for even field		Тнуо	1	-	-	Tosc	
			THVE	1	-	-	Tosc	
ENAB	Vsync-DEN time	NTSC	TVSE	-	18	-	Тн	
		PAL	TVSE	-	26	-	Тн	
	Hsync-DEN time		THE	36	68	88	Tosc	
	DEN plus width		TEP	-	320	-	Tosc	

a. Timing condition

Note : If ENAB is fixed to low, the SYNC mode is used. Otherwise DE mode is used. When SYNC mode is used, 1st data start from 68th CK after Hsync falling



4 Optical specification

Item		Symbol	Conditon	Min.	Тур.	Max.	Unit	Remark
Response	Rise	Tr	⊖ =0 °	-	15	30	ms	Note 1,2,3,5
Time	Fall	T _f		-	35	50	ms	Note 1,2,3,5
Contrast	ratio	CR	At optimized viewing angle		170	-		Note 1,2,4,5
	Тор			55	60	_		
Viewing	Botto			45	50	-		
Angle	m		CR≧10	55	60	-	deg.	Note1,2, 5,6
5	Left Right			55	60	-		
Brightne	ess	YL	l _{LED} =330mA, 25℃		500	-	cd/m²	Note 7
Bod obrom	atiaity	XR		0.592	0.622	0.652		Note 7
Red chrom	alicity	YR		0.336	0.366	0.396		For
Croop obror	noticity	XG		0.327	0.357	0.387		reference
Green chror	nationy	YG	⊖=0°	0.530	0.560	0.590		only. These
	atioity	Хв	⊖= 0 °	0.111	0.141	0.171		data should
Blue chrom	aucity	Yв	U U	0.065	0.095	0.125		be update
		Xw		0.297	0.327	0.357		according
White chron	naticity	Yw		0.318	0.348	0.378		the prototype.

4.1 Optical characteristic of the LCD

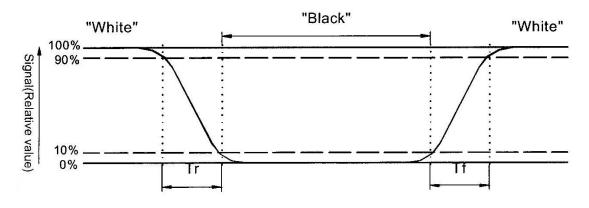
()For reference only. These data should be update according the prototype.

Note 1:Ambient temperature=25 $^{\circ}$ C, and lamp current I_L=6 mArms.To be measured in the dark room.

Note 2:To be measured on the center area of panel with a viewing cone of 1°by Topcon luminance meter BM-7,after 10 minutes operation.

Note 3.Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white"(falling time) and from"white" to "black" (rising time),respectively. The response time is defined as the time interval between the 10% and 90% of amplitudes. Refer to figure as below.



Note 4.Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Contrast ratio(CR)= Photo detector output when LCD is at "White" state Photo detector Output when LCD is at "Black" state

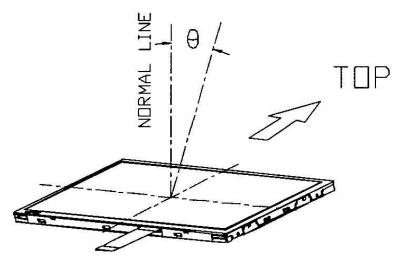
Note 5: White $V_i = V_{i50} + 1.5V$

Black V_i=V_{i50}+2.0V

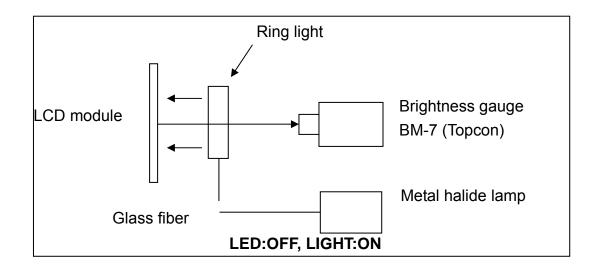
"±"means that the analog input signal swings in phase with V_{COM} signal. " $_+$ " means that the analog input signal swings out of phase with V_{COM} signal.

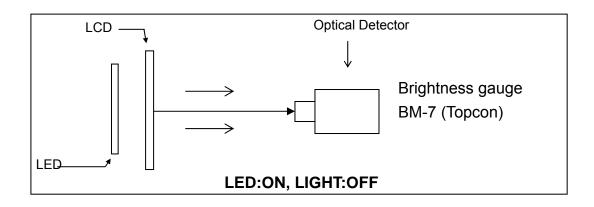
 V_{i50} : The analog input voltage when transmission is 50%. The 100% Transmission is defined as the transmission of LCD panel when all the Input terminals of module are electrically opened.

Note 6.Definition of viewing angle,Refer to figure as below.



Note 7.Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.





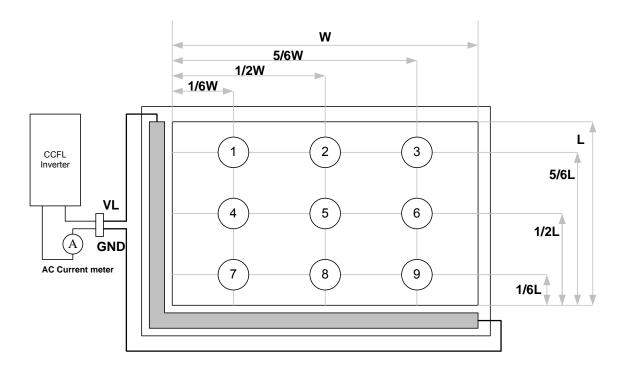
4.2 Optical characteristic of the Back-light

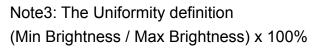
ITEM	MIN	TYP	MAX	UNIT	Condition
Bare Brightness		7000		Cd/m2	I _{LED} =330mA,Ta=25°C
AVG. X of 1931 C.I.E.	0.30	0.33	0.36		I _{LED} =330mA,Ta=25°C
AVG. Y of 1931 C.I.E.	0.31	0.34	0.37		I _{LED} =330mA,Ta=25°C
Brightness Uniformity	75			%	I _{LED} =330mA,Ta=25°C

()For reference only. These data should be update according the prototype.

Note1 : Measurement after 10 minutes from CFL operating.

Note2: Measurement of the following 9 places on the display.



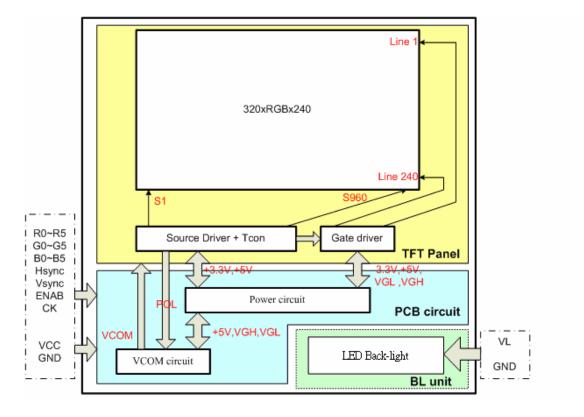


5 Interface specifications

5. I	Driving		J SIYI	lais for the TFT panel	
no S	Symbol	o Symbol	I/O	Description	Remark
1	GND	GND		Gound	
2	CK	CK		Clock signal. Latching data at the rising edge	
3	Hsync	Hsync		Horizontal sync input in digital RGB mode	
1	Vsync	Vsync		Vertical sync input in digital RGB mode	
5	GND	GND	Ι	Gound	
3	R0	R0			
7	R1	R1			
3	R2	R2		Red data	
)	R3	R3			
0	R4	R4			
1	R5	R5			
2	GND	GND		Gound	
3	G0	G0			
4	G1	G1			
5	G2	G2		Green data	
6	G3	G3			
7	G4	G4			
8	G5	G5			
9	GND	GND		Gound	
0	B0	B0			
1	B1	B1			
2	B2	B2		Blue data	
3	B3	B3			
4	B4	B4			
5	B5	B5			
6	GND	GND		Gound	
7	ENAB	ENAB	Ι	Input data enable control	
8	VCC	VCC		+3.3V Power Supply	
9	VCC	VCC			
0	R/L	R/L	I	Right / Left Reveres Mode	
1	U/D	U/D		Up / Down Reveres Mode	
2	NC	NC		Not use	
3	GND	GND		Gound	
0 1 2	R/L U/D NC	R/L U/D NC		Right / Left Reveres Mode Up / Down Reveres Mode Not use	

5.1 Driving signals for the TFT panel

6 BLOCK DIAGRAM



	Color 8 Gray	•							D	ATA S	SIGNA	L							
	Scale	R5	R4	R3	R2	R1	R0	G5	G4	G3	G2	G1	G0	B5	B4	B 3	B2	B1	B0
		0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(0)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Green(0) 0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
Basic	Blue(0)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
Color	Cyan	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1
	Magent	a 1	1	1	1	1	1	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(62) 0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0
	Red(61) 0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0
Red	:	:	:	:	:	:	:	:	:	:		:	:	:	:	:	:	:	:
Reu	Red(31) 0	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	:	:	:	:	:	:	:	:	:	:		:	:	:	:	:	:	:	:
	Red(1)	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(0)	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(6	2) 0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(6	1) 0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
Green	:	:	:	:	•••	•••	•••	•••		•••				•••			•••	•••	:
Green	Green(3	1) 0	0	0	0	0	0	0	1	1	1	1	0	0	0	0	0	0	0
	:	:	:	:	•••	•••	•••	•••						•••	•••		•••	•••	
	Green(1) 0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	0	0
	Green(0) 0	0	0	0	0	0	1	1	1	1	1	1	0	0	0	0	0	0
	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(62) 0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(61) 0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
Blue	:	:	:	:	•••	•••	•••	•••		•••				•••			•••	•••	:
Dide	Blue(31) 0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1
		:	:	:	:			:	:	:	:	:		:		:	:		:
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0
	Blue(0)	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

7 DISPLAYED COLOR AND INPUT DATA

8 QUALITY AND RELIABILITY

8.1 TEST CONDITIONS

Tests should be conducted under the following conditions : Ambient temperature : $25 \pm 5^{\circ}C$ Humidity : $60 \pm 25\%$ RH.

8.2 SAMPLING PLAN

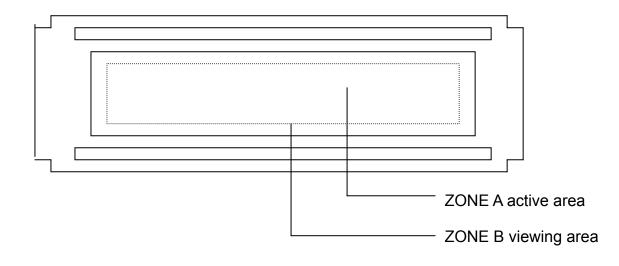
Sampling method shall be in accordance with MIL-STD-105E , level II, normal single sampling plan .

8.3 ACCEPTABLE QUALITY LEVEL

A major defect is defined as one that could cause failure to or materially reduce the usability of the unit for its intended purpose. A minor defect is one that does not materially reduce the usability of the unit for its intended purpose or is an infringement from established standards and has no significant bearing on its effective use or operation.

8.4 APPEARANCE

An appearance test should be conducted by human sight at approximately 30 cm distance from the LCD module under flourescent light. The inspection area of LCD panel shall be within the range of following limits.



8.5 INSPECTION QUALITY CRITERIA

No.	ltem	Criterior	Defect type		
1	Non display	No non display is allowed			Major
2	Irregular operation	No irregular operation is al	lowed		Major
3	Short	No short are allowed	Major		
4	Open	Any segments or commor rejectable.	Major		
5	Mura/Spot	ND 3% filter visible is reject ND 3% filter visible is reject	Major		
6	Line defect	Inspected Items Weak line Clear Line Broken Line One point one weak line / Sipder missing line	NI	Criteria D 6%see,Reject Reject Reject Reject	Major
7	Black/White spot (II)	Size D (mm) $D \le 0.30$ $0.30 < D \le 0.50$ $0.50 < D \le 1.20$ $1.20 < D$	Acc	Minor	
8	Black/White line (II)	Length (mm)Width (m $20 < L$ $0.05 < W \le 0$ $10 < L \le 20$ $0.07 < W \le 0$ $5.0 < L \le 10$ $0.09 < W \le 0$ $L \le 5.0$ $0.10 < W \le 0$).07).09).10	Acceptable number 5 3 2 1	Minor
9	Back Light	1. No Lighting is rejectable 2. Flickering and abnorma	Major		
10	Display pattern	A + B ≤ 0.30 0 < C Note: 1. Acceptable up to 3 d 2. NG if there're to two	Minor		

$11 \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ $	
$11 \begin{array}{ c c c c c c } \hline & & & & & & & & & & & & & & & & & & $	
$11 \begin{array}{ c c c c c c } & & & & & & & & & & & & & & & & & & &$	
$11 \begin{array}{ c c c c c c c } \hline Foreign \\ Material Defect. \end{array} \begin{array}{ c c c c c } \hline Bright line \\ defect \\ \hline \\ \\ \hline \\ \\ \\ \hline \\ \hline \\ \\ \hline \\ \hline \\ \\ \hline \\ \\ \hline \\ \hline \\ \\ \hline \\ \hline \\ \\ \hline \\ \\ \hline \\ \hline \\ \\ \hline \hline \\ \hline \\ \hline \\ \hline \hline \hline \\ \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \\ \hline \hline \hline \hline \hline \\ \hline \hline$	
$11 \begin{array}{ c c c c c } Foreign \\ Material Defect. \end{array} \begin{array}{ c c c c c } Foreign \\ Material Defect. \end{array} \begin{array}{ c c c c } \hline Diright Middle \\ \hline Diright Spot \\ \hline defect \\ \hline D \leq 0.15mm \\ \hline D \geq 0.3mm \\ \hline N \leq 3 \\ \hline D \geq 0.3mm \\ \hline Reject \\ \hline Dark line \\ \hline defect \\ \hline Dark Spot \\ \hline D \leq 0.15mm \\ \hline D \geq 0.3mm \\ \hline Reject \\ \hline Dark Spot \\ \hline D \leq 0.15mm \\ \hline Since \\ \hline Since \\ \hline D \leq 0.15mm \\ \hline Since \\$	
$11 \begin{array}{ c c c c c } \hline Foreign \\ Material Defect. \end{array} \begin{array}{ c c c c } \hline Bright Spot \\ \hline Defect \\ \hline Defect$	
$11 \begin{array}{ c c c c } Foreign \\ Material Defect. \end{array} \begin{array}{ c c c } \hline Bright Spot \\ defect \\ \hline Dark line \\ defect \\ \hline Dark Spot \\ \hline Dark Spot \\ \hline D \leq 0.15mm \\ \hline D \leq 0.3mm \\ \hline N \leq 3 \\ \hline D > 0.3mm \\ \hline Reject \\ \hline M > 0.05mm \\ \hline \end{array}$	
$11 \begin{array}{ c c c c c } \hline Foreign \\ Material Defect. \end{array} \begin{array}{ c c c c c } \hline Foreign \\ Material Defect. \end{array} \begin{array}{ c c c c c } \hline O.15mm < D \leq 0.3mm & N \leq 3 \\ \hline D>0.3mm & Reject \\ \hline Dark line \\ defect \\ \hline L \leq 2.0mm & Ignore \\ \hline M \leq 0.05mm \\ \hline L \leq 3.0mm & N \leq 4 \\ \hline Dark Spot \\ \hline D \leq 0.15mm & Ignore \\ \hline M \leq 0.05mm \\ \hline M \equiv 0.05mm \\ \hline M \hline$	
$\begin{array}{c c c c c c } \hline 11 & & & & & & & & & & & & & & & & & $	
$\begin{array}{ c c c c c c } \hline 11 & \hline \\ \hline$	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Minor
L>3mm Reject Dark Spot D ≤0.15mm Ignore W>0.05mm	
Dark Spot D ≤0.15mm Ignore W>0.05mm	
	-
	i
L>0.5mm Reject	
11.1 Bright defect use ND 10% to inspect, if they will be seen, then us	ing
point defect or line defect to judge again.	
11.2 Any two points distance ≥ 5 mm	
	,
Width (mm) Length (mm) Acceptable number	4
Scratch on W<0.03 Ignore Ignore	
Polarizer $0.03 < W \le 0.05$ $L \le 2.0$ Ignore	
12 L>2.0 1	Minor
12 0.05 <w<u><0.08 L > 1.0 1</w<u>	
$L \leq 1.0$ Ignore	
0.08 <w (1)="" note="" note(1)<="" td=""><td></td></w>	
Note(1) Regard as a blemish	
Note(2) Distance LCM 30cm, base on visible scratch.	
Distance LCM 30cm, base on visible.	
Size D (mm) Acceptable number]
Bubble in $D < 0.20$ Japore	
$\begin{bmatrix} 13 & D & 0.20 \\ polarizer & 0.20 < D \le 0.50 \end{bmatrix}$	Minor
$0.50 < D \le 0.80$ 2	
0.80 < D 0	
	J
Stains on Stains that cannot be removed even when wiped lig	htly
14 LCD panel with a soft cloth or similar cleaning too are rejectable.	Minor
surface Distance LCM 30cm, base on visible.	WIITO
15 Rust in Bezel Rust which is visible in the bezel is rejectable.	Minor
	IVIII IOI
Defect of	
land surface	
	Minor
soldering)	
1. Failure to mount parts	Major
17 Parts 2 Parts not in the specifications are mounted	Major
3. Polarity, for example, is reversed	Major
1. LSI, IC lead width is more than 50% beyond pad outl	ine. Minor
18 Pails 2 Chin component is off center and more than 50% of	the
	Minor
leads is off the pad outline.	

	Conductive foreign matter	2. 0.30<	φ ,N φ <u><</u> 0.45 ,N	≧1			Major Minor
19	(Solder ball, Solder chips)	3. 0.50 <l< td=""><td>,N</td><td>≧1</td><td>der ball (unit: ı chip (unit: mn</td><td>,</td><td>Minor</td></l<>	,N	≧1	der ball (unit: ı chip (unit: mn	,	Minor
20	Faulty PCB correction	1. Due to conne place	Minor				
	correction	2. Short been	Minor				
				have brigh hber defect	it dot or Dark o ion:	dot.	
21	Defect Dot	Bright dot	Dark dot	Total dot	Distance between Dark dark		Minor
		3	5	7	$L \ge 5 \text{ mm}$		

8.6 RELIABILITY

Test Item	Test Conditions						
High Temperature Operation	70±3°C , t=96 hrs						
Low Temperature Operation	-20±3°C , t=96 hrs						
High Temperature Storage	80±3°C , t=96 hrs	1,2					
Low Temperature Storage	-30±3°C , t=96 hrs	1,2					
Thermal Shock Test	-20°C ~ 25°C ~ 70°C 30 m in. 5 min. 30 min. (1 cycle) Total 5 cycle	1,2					
Humidity Test	40 °C, Humidity 90%, 96 hrs	1,2					
Vibration Test (Packing)	Sweep frequency : 10 ~ 55 ~ 10 Hz/1min Amplitude : 0.75mm Test direction : X.Y.Z/3 axis Duration : 30min/each axis	2					

Note 1 : Condensation of water is not permitted on the module.

Note 2 : The module should be inspected after 1 hour storage in normal conditions (15-35°C, 45-65%RH).

Definitions of life end point :

- Current drain should be smaller than the specific value.
- Function of the module should be maintained.
- Appearance and display quality should not have degraded noticeably.
- Contrast ratio should be greater than 50% of the initial value.

USE PRECAUTIONS

9 HANDLING PRECAUTIONS

- (1) An LCD module is a fragile item and should not be subjected to strong mechanical shocks.
- (2) Avoid applying pressure to the module surface. This will distort the glass and cause a change in colour.
- (3) Under no circumstances should the position of the bezel tabs or their shape be modified.
- (4) Do not modify the display PCB in either shape or positioning of components.
- (5) Do not modify or move location of the zebra or heat seal connectors.
- (6) The device should only be soldered to during interfacing. Modification to other areas of the board should not be carried out.
- (7) In the event of LCD breakage and resultant leakage of fluid do not inhale, ingest or make contact with the skin. If contact is made rinse immediately.
- (8) When cleaning the module use a soft damp cloth with a mild solvent, such as Isopropyl or Ethyl alcohol. The use of water, ketone or aromatic is not permitted.
- (9) Prior to initial power up input signals should not be applied.
- (10) Protect the module against static electricity and observe appropriate anti-static precautions.

9.1 Installing precautions

1) The PCB has many ICs that may be damaged easily by static electricity. To prevent breaking by static electricity from the human body and clothing, earth the human body properly using the high resistance and discharge static electricity during the operation. In this case, however, the resistance value should be approx. $1M\Omega$ and the resistance should be placed near the human body rather than the ground surface. When the indoor space is dry, static electricity may occur easily so be careful. We recommend the indoor space should be kept with humidity of 60% or more. When a soldering iron or other similar tool is used for assembly, be sure to earth it.

- 2) When installing the module and ICs, do not bend or twist them. Failure to do so may crack LC element and cause circuit failure.
- 3) To protect LC element, especially polarizing plate, use a transparent protective plate (e.g., acrylic plate, glass etc) for the product case.
- 4) Do not use an adhesive like a both-side adhesive tape to make LCD surface (polarizing plate) and product case stick together. Failure to do so may cause the polarizing plate to peel off.

9.2 Storage precautions

- Avoid a high temperature and humidity area. Keep the temperature between 0°C and 35°C and also the humidity under 60%.
- Choose the dark spaces where the product is not exposed to direct sunlight or fluorescent light.
- Store the products as they are put in the boxes provided from us or in the same conditions as we recommend.

9.3 Operating precautions

- 1) Do not boost the applied drive voltage abnormally. Failure to do so may break ICs. When applying power voltage, check the electrical features beforehand and be careful. Always turn off the power to the LC module controller before removing or inserting the LC module input connector. If the input connector is removed or inserted while the power is turned on, the LC module internal circuit may break.
- 2) The display response may be late if the operating temperature is under the normal standard, and the display may be out of order if it is above the normal standard. But this is not a failure; this will be restored if it is within the normal standard.
- The LCD contrast varies depending on the visual angle, ambient temperature, power voltage etc. Obtain the optimum contrast by adjusting the LC dive voltage.
- 4) When carrying out the test, do not take the module out of the low-temperature space suddenly. Failure to do so will cause the module condensing, leading to malfunctions.
- 5) Make certain that each signal noise level is within the standard (L level: 0.2Vdd or less and H level: 0.8Vdd or more) even if the module has functioned properly. If it is beyond the standard, the module may often malfunction. In addition, always connect the module when making noise level measurements.
- 6) The CMOS ICs are incorporated in the module and the pull-up and pull-down

function is not adopted for the input so avoid putting the input signal open while the power is ON.

- 7) The characteristic of the semiconductor element changes when it is exposed to light emissions, therefore ICs on the LCD may malfunction if they receive light emissions. To prevent these malfunctions, design and assemble ICs so that they are shielded from light emissions.
- 8) Crosstalk occurs because of characteristics of the LCD. In general, crosstalk occurs when the regularized display is maintained. Also, crosstalk is affected by the LC drive voltage. Design the contents of the display, considering crosstalk.

9.4 Other

- 1) Do not disassemble or take the LC module into pieces. The LC modules once disassembled or taken into pieces are not the guarantee articles.
- 2) The residual image may exist if the same display pattern is shown for hours. This residual image, however, disappears when another display pattern is shown or the drive is interrupted and left for a while. But this is not a problem on reliability.

10 OUTLINE DIMENSION

